

Measurements of optical loss in GaAs/Al₂O₃ nonlinear waveguides in the infrared using femtosecond scattering technique

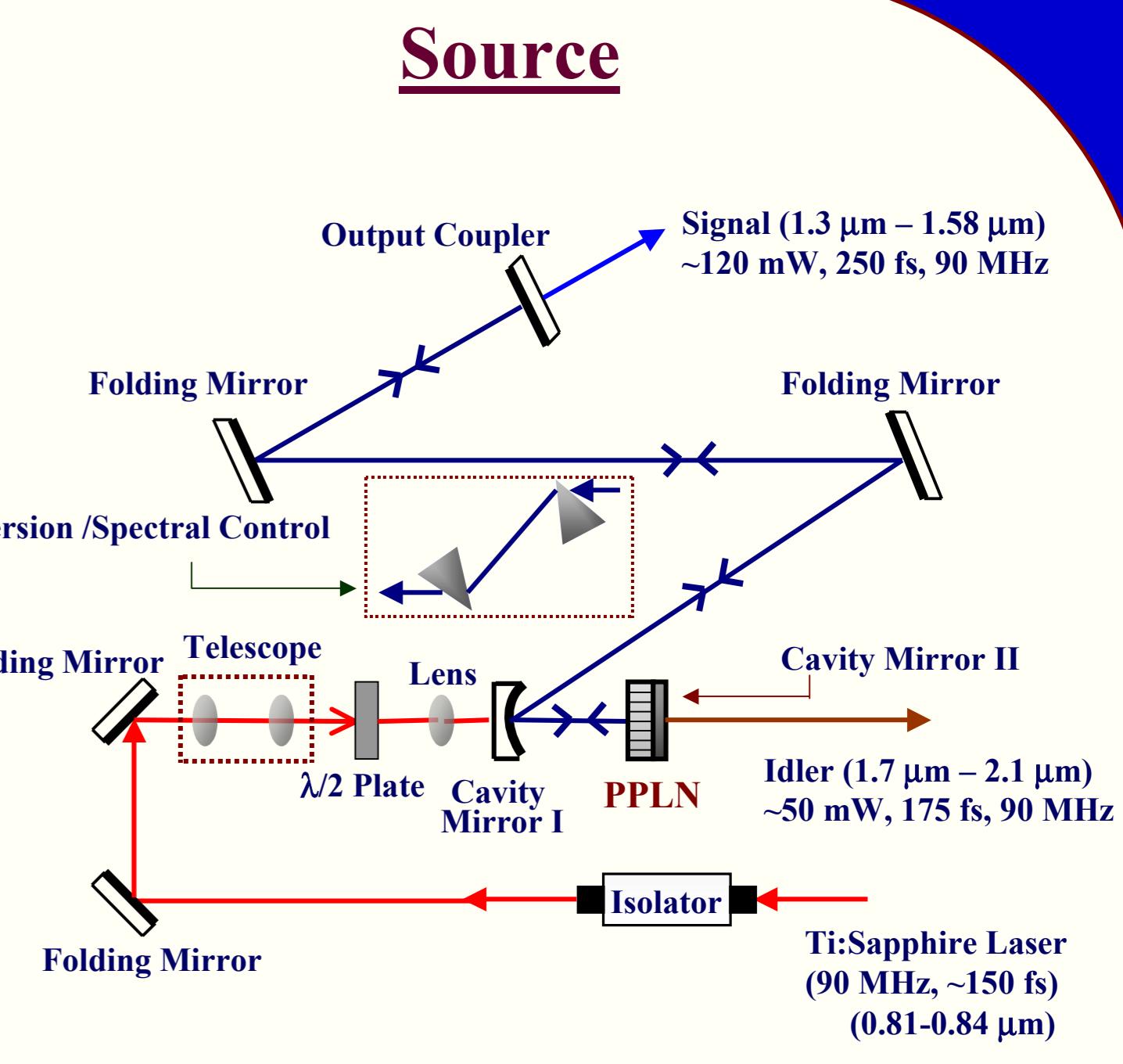
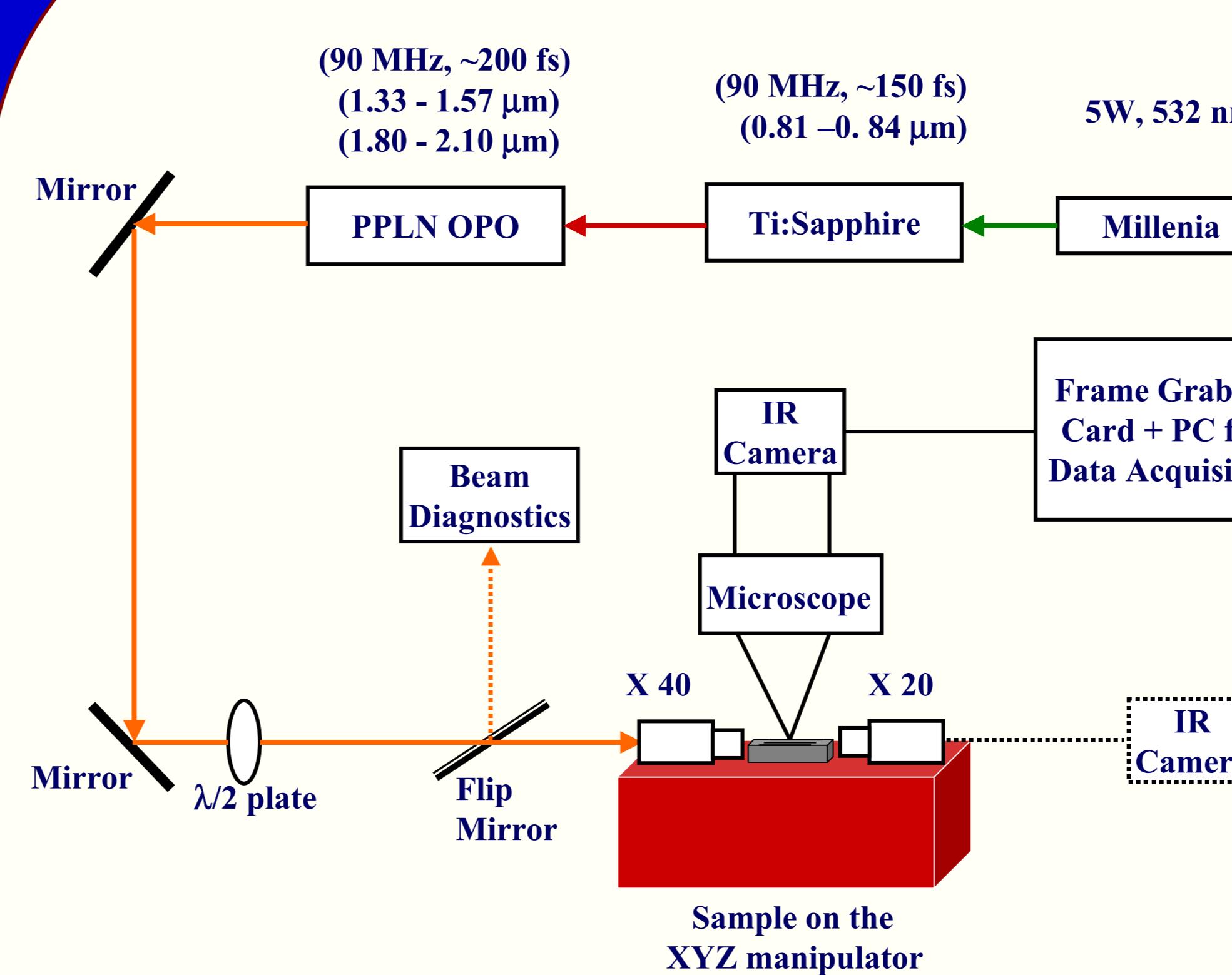
S. Venugopal Rao ⁽¹⁾, K. Moutzouris ⁽¹⁾, M. Ebrahimzadeh ⁽¹⁾
A. De Rossi ⁽²⁾, G. Gintz ⁽²⁾, M. Calligaro ⁽²⁾, V. Ortiz ⁽²⁾, and V. Berger ⁽²⁾

(1) School of Physics and Astronomy, University of St. Andrews, North Haugh, Fife, KY16 9SS, Scotland, UK
(2) THALES, Laboratoire Central de Recherches, Domaine de Corbeville, 91400 Orsay, France

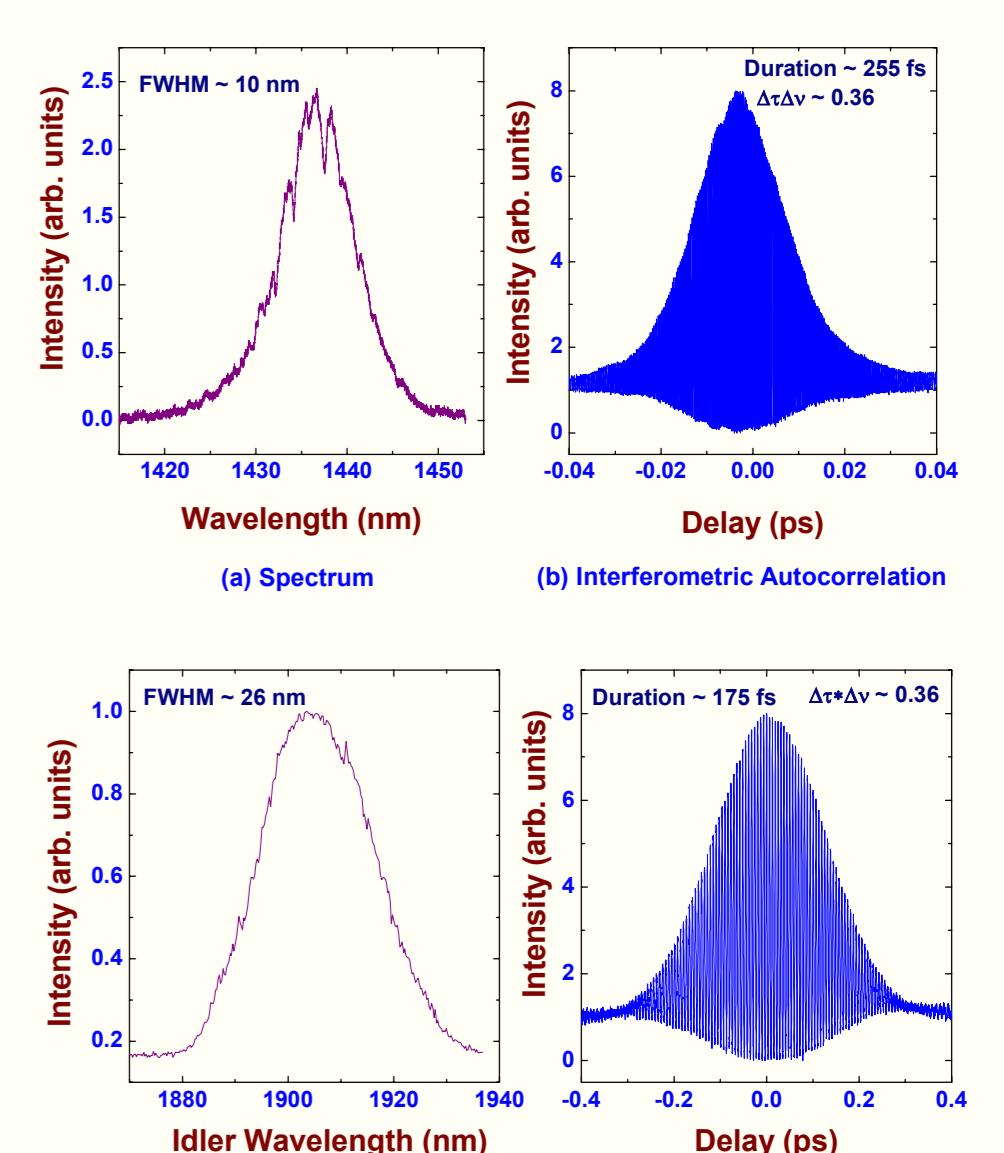
INTRODUCTION

- Optical loss:** Important in the assessment of semiconductor nonlinear waveguides (SHG, DFG, and OPO's)
- Difficulties**
 - Inaccurate knowledge of effective refractive indices
 - Unknown facet reflectivities
- Techniques used** Cutback method, Prism coupling, Photo-thermal deflection, **Fabry-Perot (FP) interference method**, Photo-luminescence, Optimized end-fire coupling, Self-pumped phase conjugation, Multisection single-pass technique and **Scattering technique**
 - Advantages**
 - For waveguides with losses >1 dB/cm
 - Disadvantages**
 - Not universally appealing: Complexity (eg. self-pumped phase conjugation) or Destructive nature (eg. cut back)
 - Measurements at a single wavelength
- FP technique:** The most successful approach for evaluation of losses <1 dB/cm.
 - Pros**
 - Simple
 - Robust
 - Non-destructive
 - Cons**
 - Stringent frequency stability requirements
 - Accurate knowledge of facet reflectivities
 - Precision in the facet parallelism of the waveguide etalon
- Scattering technique**
 - Pros**
 - Uncomplicated
 - No stringent requirements
 - Non-destructive
 - Cons**
 - Not very accurate data for <0.5 dB/cm losses
- Advantages of using an fs OPO:**
 - Continuous tunability
 - Knowledge about interaction/propagation of fs pulses within waveguide (useful for TDM and WDM)

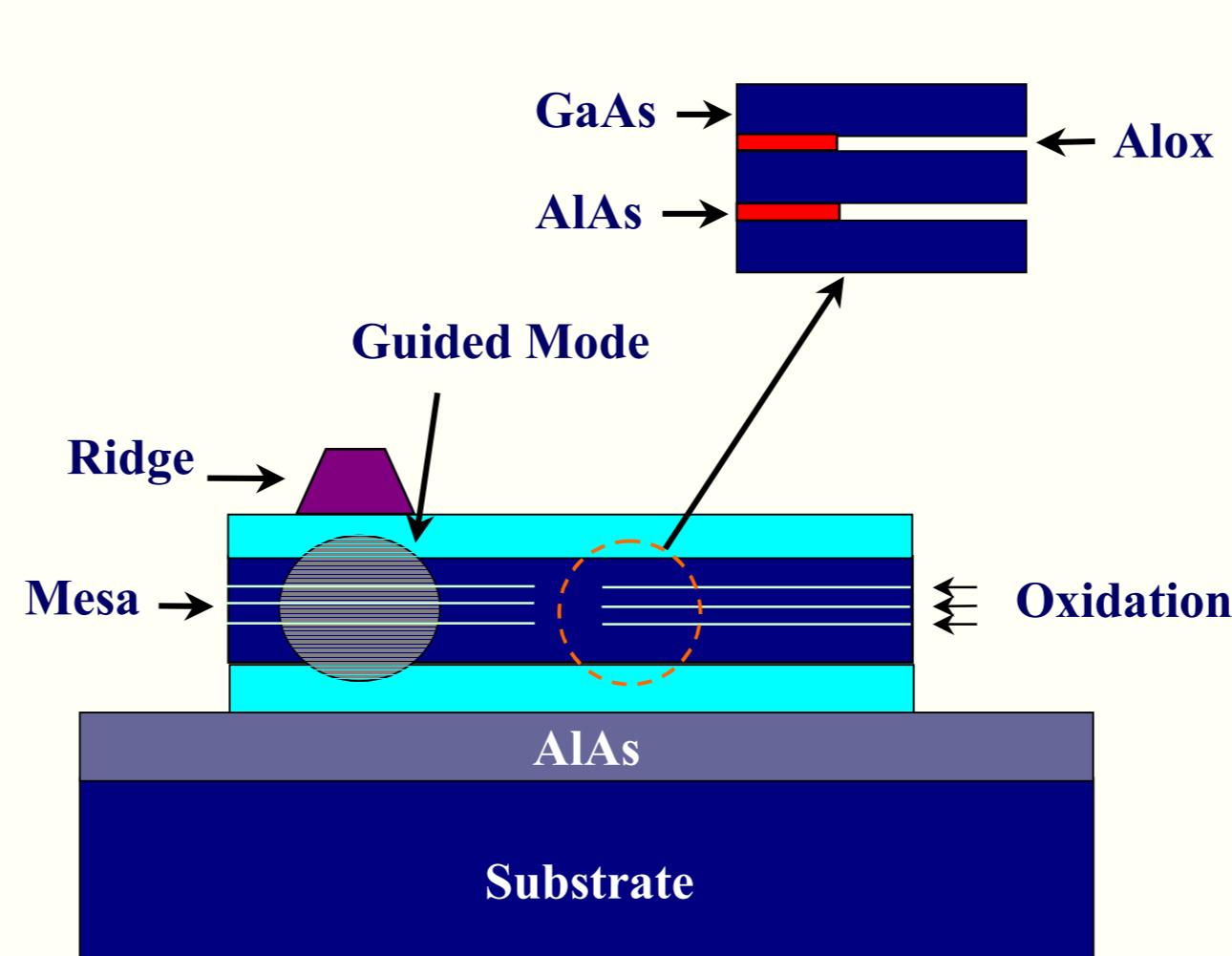
EXPERIMENT



Source Characteristics



Sample

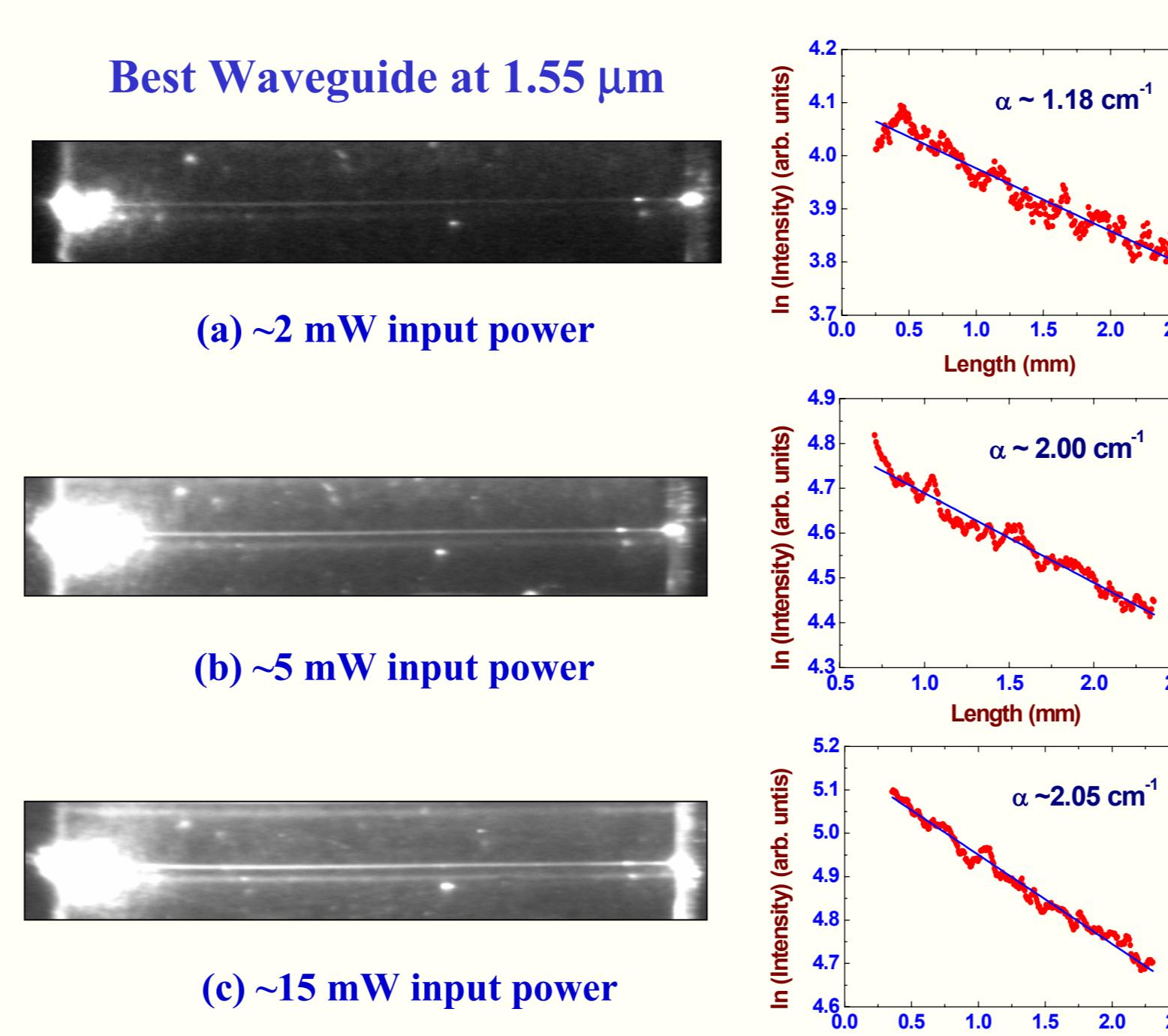
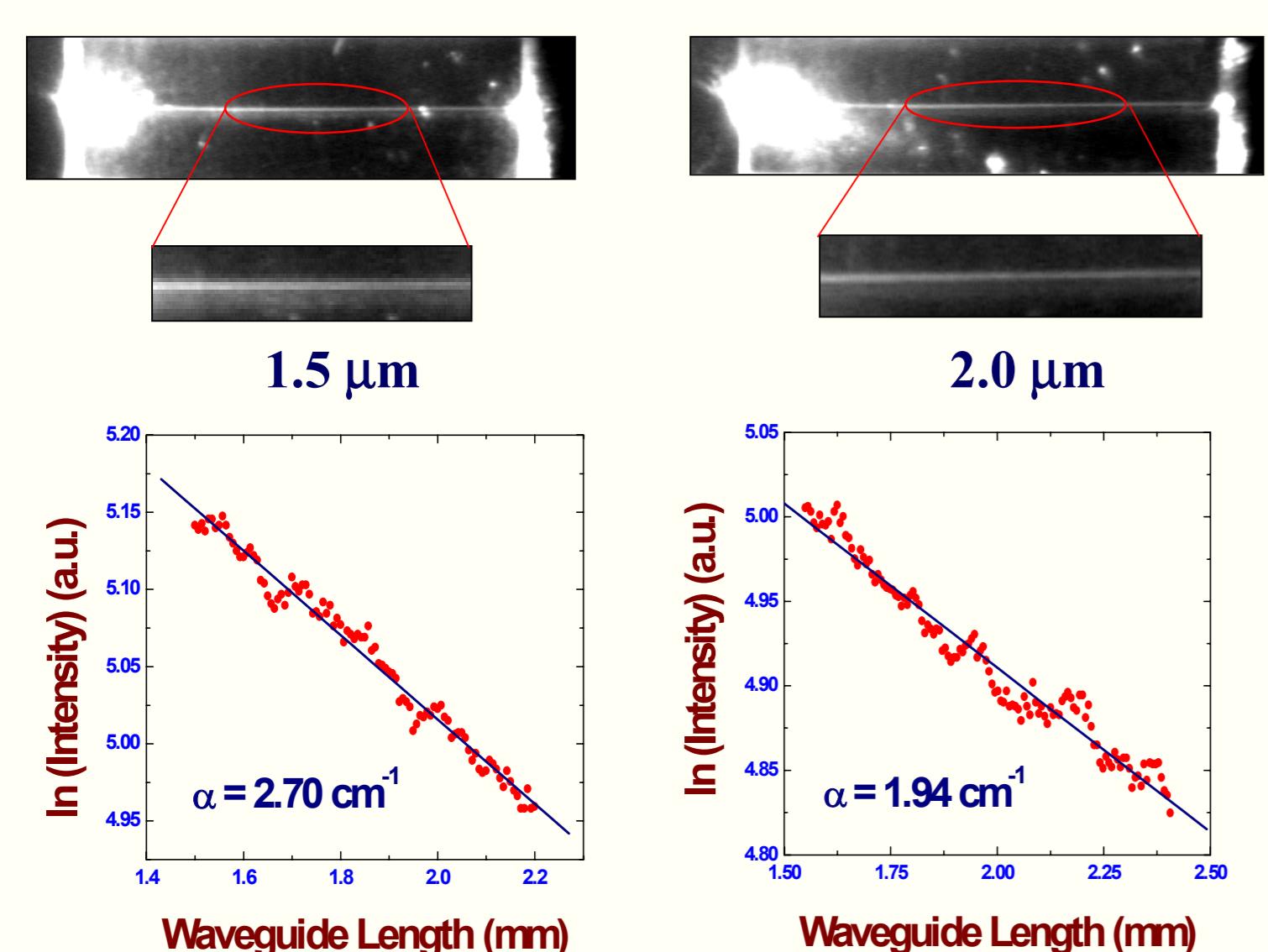


- (GaAs <001> substrate) / 1000 nm AlAs / 1000 nm Al_{0.7}Ga_{0.3}As / 4 X (37 nm AlAs / 273 nm GaAs) / 37 nm AlAs / 1000 nm Al_{0.7}Ga_{0.3}As / 30 nm GaAs.

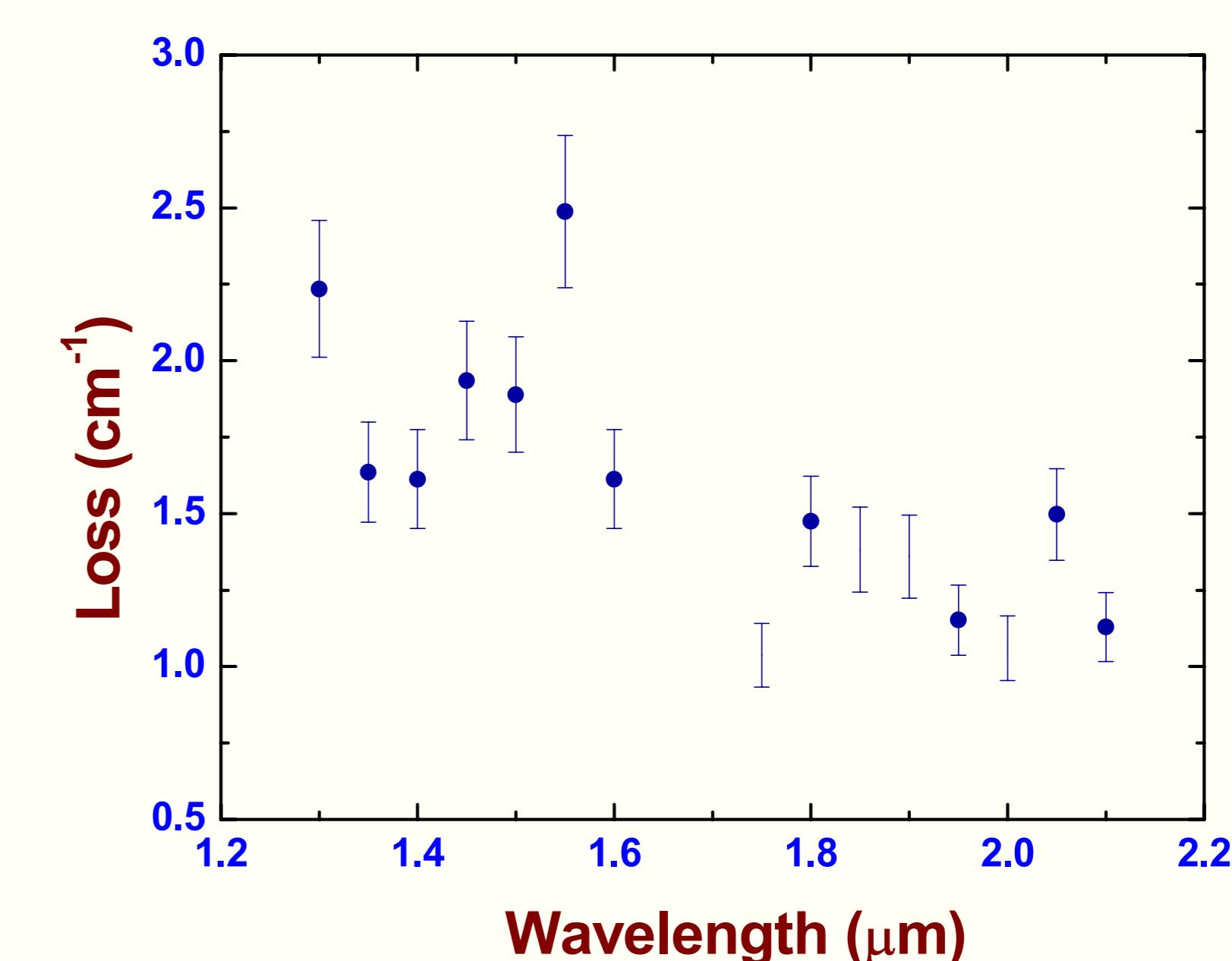
Process steps:

- Ridge etching (optical confinement)
- Mesa etching (lateral oxidation)
- Oxidation
- Annealing (interface quality)

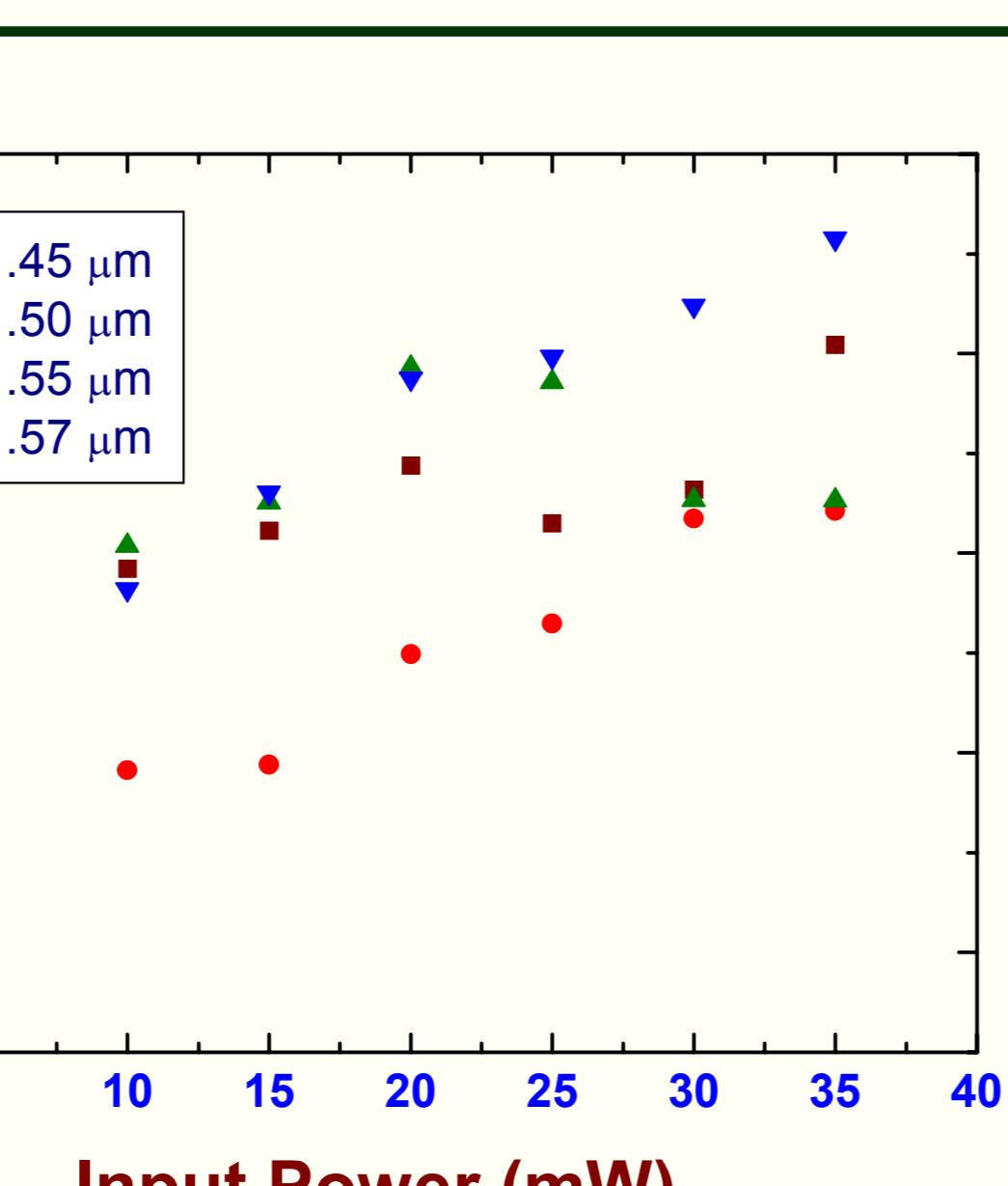
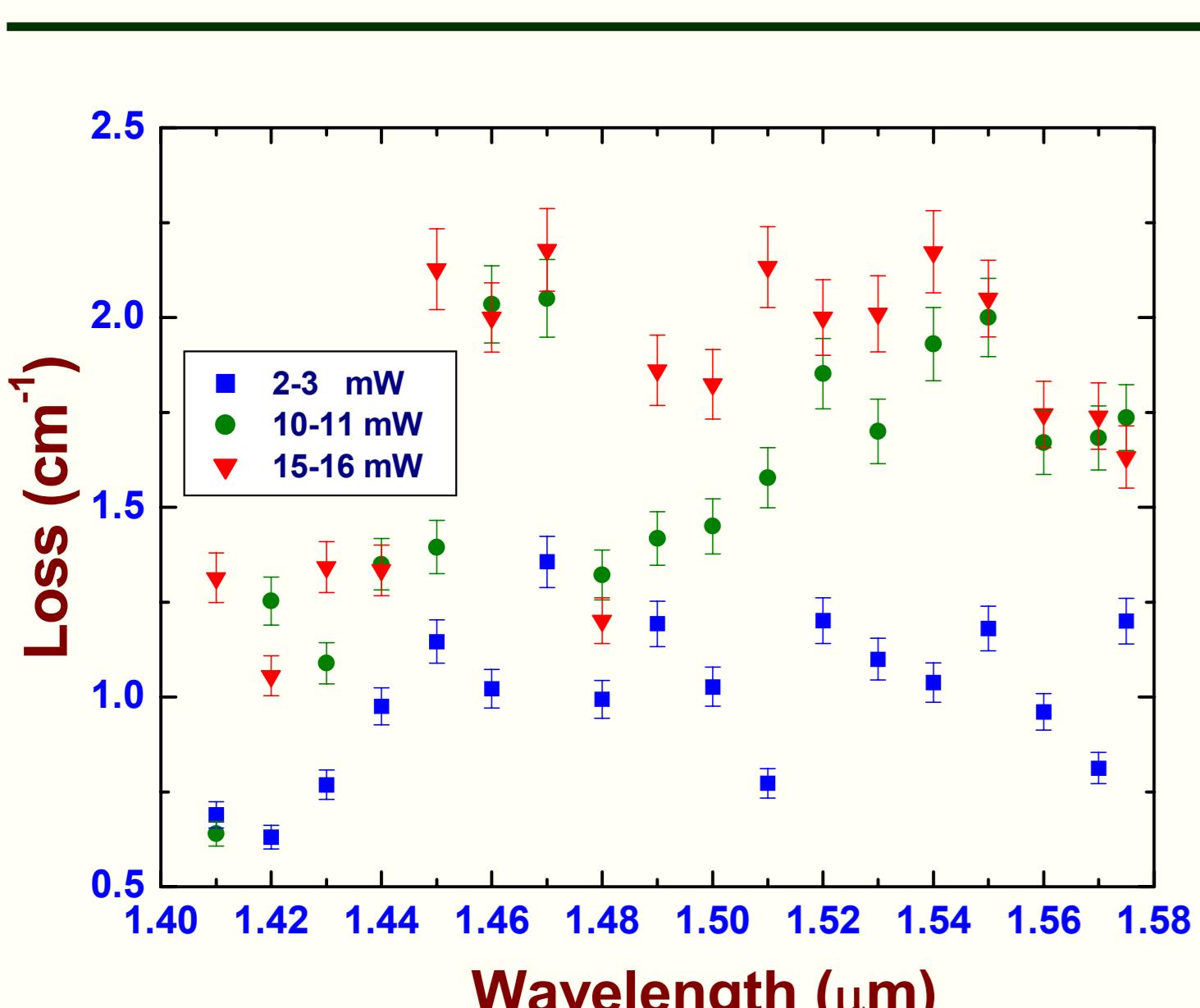
RESULTS



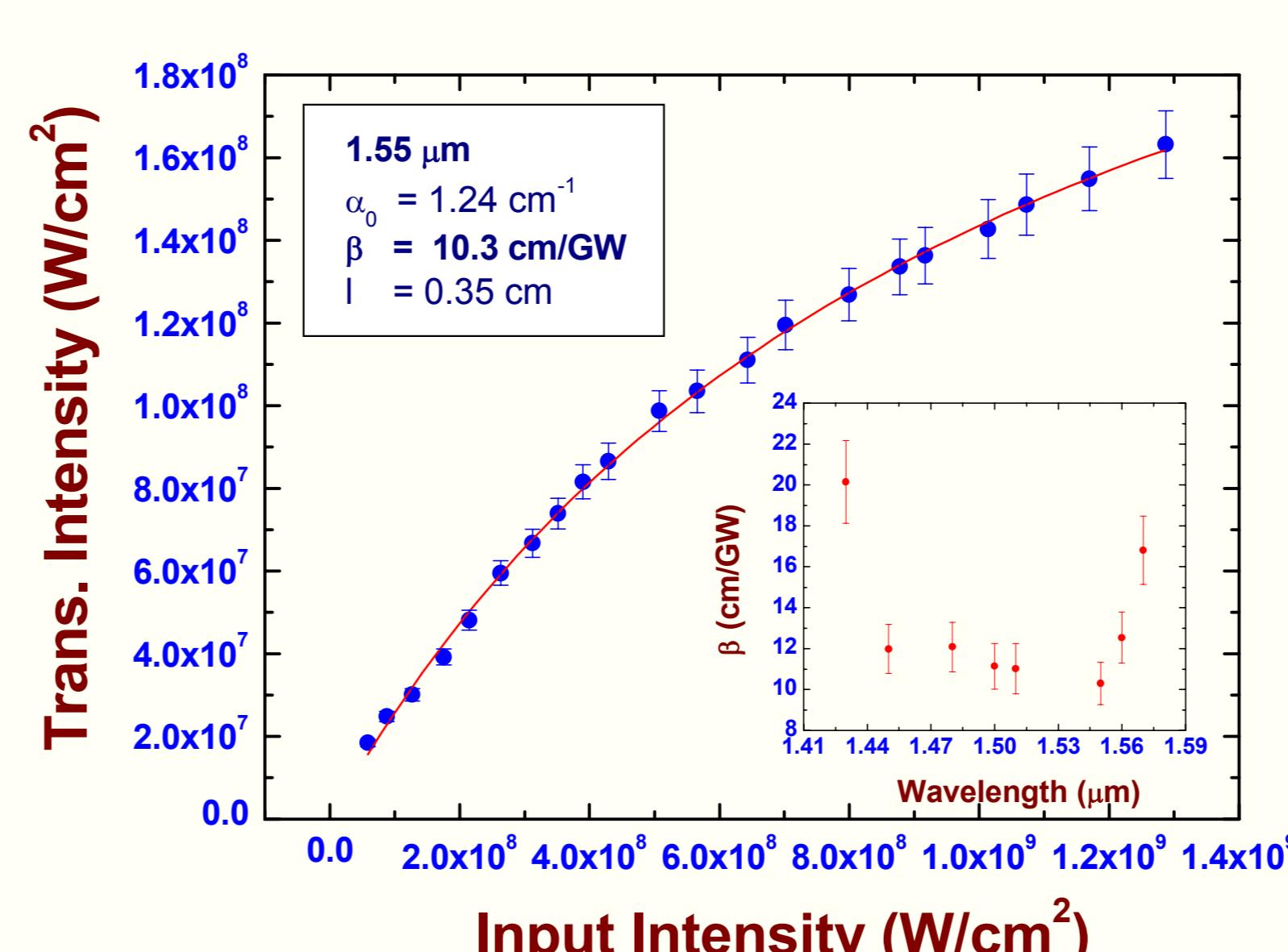
➤ $I_L = I_0 e^{(-\alpha L)}$, where I_L is the scattered intensity after a propagation length L through the waveguide; I_0 is the initial intensity at the start of the path, and α is the overall loss coefficient



- $\alpha \sim 5-11$ dB/cm in the range 1.35-1.58 μm and 1.75-2.10 μm ⇒ loss coefficients of ~1.15-2.55 cm⁻¹. Using cw FP technique α is ~1.0 cm⁻¹ at 1.30 μm
- Higher Loss at shorter wavelengths compared to longer wavelengths: Scattering ($1/\lambda^2$) or TPA?

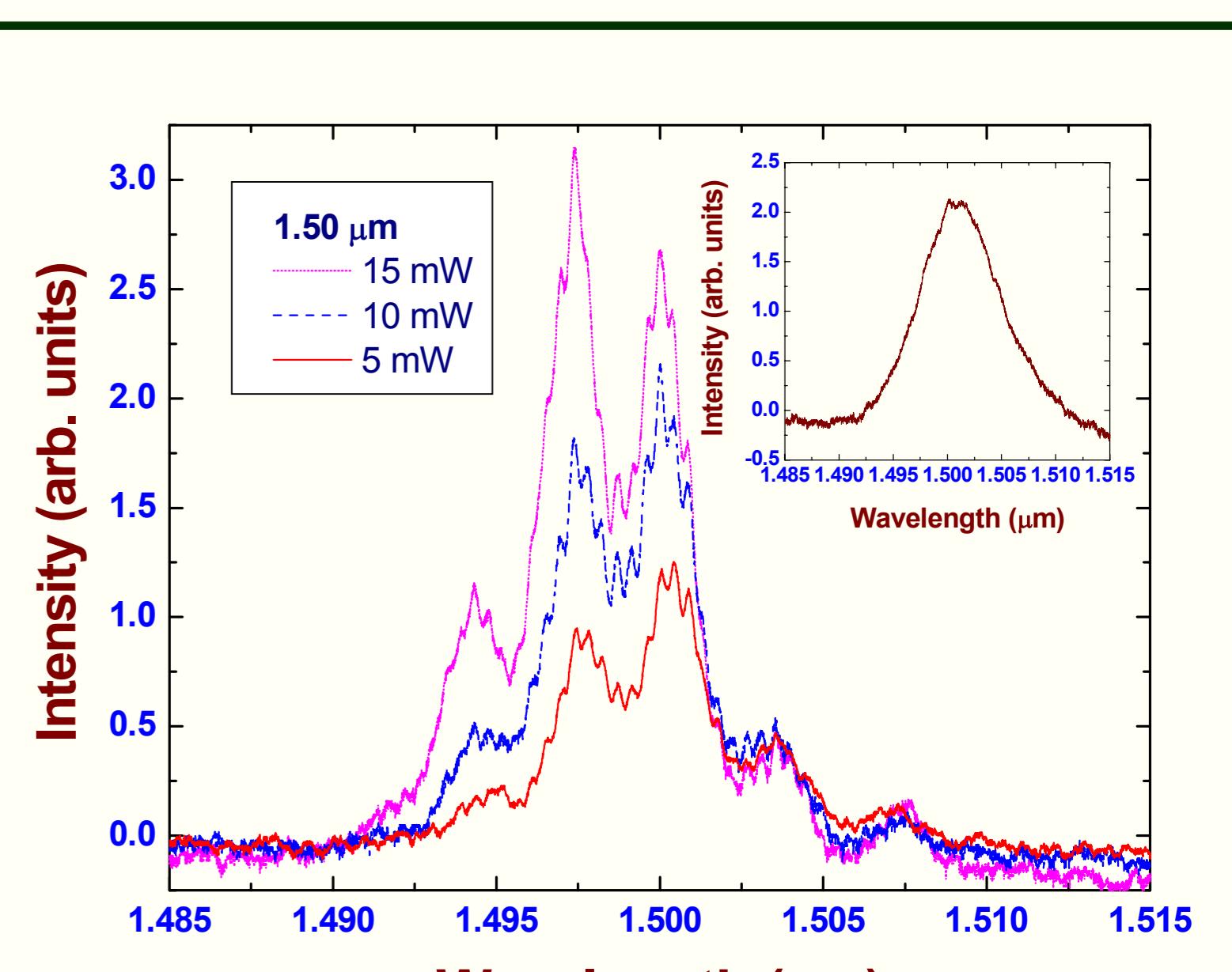


- Loss higher for TM and TE+TM polarization compared to TE polarization
- No clear dependence on the mode structure: same loss for TE₀₀ and higher order modes.
- $\alpha \sim 1.0$ cm⁻¹ ~2 mW ; ~1.5 cm⁻¹ and ~2.0 cm⁻¹, respectively, for ~10 mW and ~15 mW
- Overall loss = Linear loss due to absorption
 - + Loss due to scattering from waveguide
 - + Loss due to scattering from Alox
 - + Loss due to Two Photon Absorption (TPA) (~250 fs pulses).



$$\frac{dI(r, z, t)}{dz} = -\alpha_0 I(r, z, t) - a \beta I^2(r, z, t)$$

- α_0 was fixed with loss value at low input powers
- TPA coefficient $\beta \sim 10-18$ cm/GW.



- Temporal pulse broadening (due to GVD) is ~1.02 times, which is quite negligible.
- $n_2 \sim 9 \times 10^{-13}$ cm²/W at 1.55 μm
- $n_2 \sim 7 \times 10^{-13}$ cm²/W and $\sim 3 \times 10^{-13}$ cm²/W at 1.45 μm and 1.55 μm respectively

CONCLUSIONS

- Losses have been evaluated for a wide range of wavelengths in the infrared (1.35-1.58 μm and 1.75-2.10 μm) using the femtosecond scattering technique
- Loss coefficients of ~1.15-2.55 cm⁻¹ were obtained for the best waveguide corresponding to ~5-11 dB/cm. $\alpha \sim 1.0$ cm⁻¹ at 1.30 μm (cw FP technique). Losses were higher at lower wavelengths (<1.6 μm)
- Intensity dependent nonlinear transmission studies enabled to identify the magnitude of TPA contribution
- At very low input powers the major contribution is from absorption + scattering from waveguide and Alox with typical values of ~1-1.5 cm⁻¹. At higher input powers (~15 mW) a TP component of almost ~1.5 cm⁻¹ also contributes to the total loss measured

REFERENCES

- K. Moutzouris, S. Venugopal Rao, et al. Opt. Lett. **26**, 1785 (2001)
- R. Regener and W. Sohler, Appl. Phys. B **36**, 143 (1985); R. Arsenault, D. Gregoris, S. Woolven, and V.M. Ristic, Opt. Lett. **12**, 1047 (1987)
- M.R. Amersfoort, D. Grutzmacher, M.K. Smit, and Y.S. Oei, Electron. Lett. **27**, 1152 (1991), M. Haruna, Y. Segawa, and H. Nishihara, Electron. Lett. **28**, 1612 (1992)
- S. Brülisauer, D. Fluck, C. Solcia, T. Pliska, and P. Günter, Opt. Lett. **20**, 1773 (1995); Y. Okamura, S. Yoshinaka, and S. Yamamoto, Appl. Opt. **22**, 3892 (1983)
- Y. Sidorin, Opt. Commun. **194**, 325 (2001); M. Kumar et al. IEEE Phot. Tech. Lett. **4**, 435 (1993); M. Kumar et al. J. Appl. Phys. **82**, 3205 (1997); C.C. Yang et al. IEEE J. Quant. Electron., **29** 2934 (1993)